

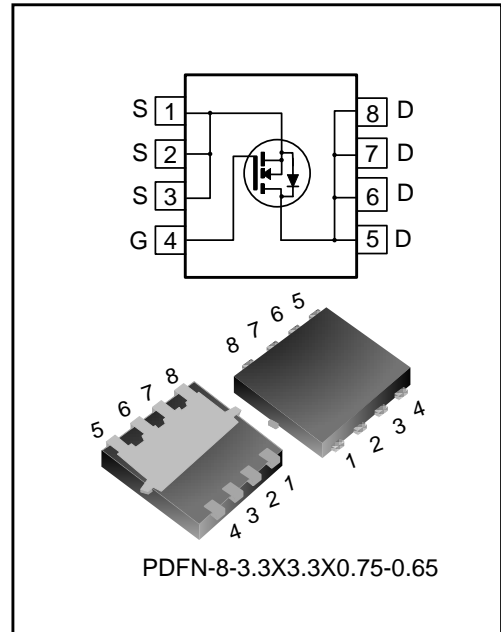
100A, 30V N-CHANNEL MOSFET

DESCRIPTION

SVG032R4NL3 is an N-channel enhancement mode power MOS field effect transistor which is produced using Silan's LVMOS technology. The improved process and cell structure have been especially tailored to minimize on-state resistance, provide superior switching performance and high avalanche breakdown tolerance. This device is widely used in power management for UPS and Inverter Systems.

FEATURES

- ◆ 100A, 30V, $R_{DS(on)(typ.)}=2.0m\Omega@V_{GS}=10V$
- ◆ Low gate charge
- ◆ Low C_{rss}
- ◆ Fast switching
- ◆ Extreme dv/dt rated
- ◆ 100% avalanche tested
- ◆ Pb-free lead plating
- ◆ RoHS compliant



KEY PERFORMANCE PARAMETERS

Characteristics	Ratings	Unit
V_{DS}	30	V
$V_{GS(th)}$	1.3~2.3	V
$R_{DS(on),max.}$	2.4	$m\Omega$
I_D	100	A
$Q_{g,typ.}$	40	nC

ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing Type
SVG032R4NL3TR	PDFN-8-3.3x3.3x0.75-0.65	32R4	Halogen free	Tape & Reel

ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED, $T_J=25^{\circ}\text{C}$)

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Drain-source Voltage	V_{DS}	--	30	--	--	V
Gate-source Voltage	V_{GS}	--	-20	--	20	V
Drain Current (Note 1)	I_D	$T_C=25^{\circ}\text{C}$	--	--	100	A
		$T_C=100^{\circ}\text{C}$	--	--	63	
Drain Current Pulsed (Note 2)	I_{DM}	$T_C=25^{\circ}\text{C}$	--	--	400	A
Power Dissipation (Note 3)	P_D	$T_C=25^{\circ}\text{C}$	--	--	43	W
Single Pulsed Avalanche Energy	E_{AS}	$L=0.1\text{mH}$, $V_{DD}=24\text{V}$, $R_G=25\Omega$, starting temperature $T_J=25^{\circ}\text{C}$	--	--	101	mJ
Single Pulsed Current	I_{AS}	--	--	--	45	A
Operation Junction Temperature Range	T_J	--	-55	--	150	$^{\circ}\text{C}$
Storage Temperature Range	T_{stg}	--	-55	--	150	$^{\circ}\text{C}$

THERMAL CHARACTERISTICS

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Thermal Resistance, Junction-case, Bottom	$R_{\theta JC}$	--	--	--	2.9	$^{\circ}\text{C/W}$
Thermal Resistance, Junction-ambient	$R_{\theta JA}$	--	--	--	59	$^{\circ}\text{C/W}$
Soldering Temperature(SMD)	T_{sold}	Reflow soldering: $10 \pm 1\text{sec}$, 3times	--	--	260	$^{\circ}\text{C}$

ELECTRICAL CHARACTERISTICS (UNLESS OTHERWISE NOTED, $T_J=25^{\circ}\text{C}$)

Static characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Drain-source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	30	--	--	V
Drain-source Leakage Current	I_{DSS}	$V_{DS}=30V, V_{GS}=0V, T_J=25^{\circ}\text{C}$	--	--	1.0	μA
		$V_{DS}=30V, V_{GS}=0V, T_J=125^{\circ}\text{C}$	--	2.0	--	
Gate-source Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	--	--	± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	1.3	--	2.3	V
Static Drain-source On State Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=22.5A$	--	2.0	2.4	$m\Omega$
		$V_{GS}=4.5V, I_D=22.5A$	--	3.0	3.8	$m\Omega$
Gate Resistance	R_g	$f=1\text{MHz}$	--	2.9	--	Ω

Dynamic characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Input Capacitance	C_{iss}	$f=1\text{MHz}, V_{GS}=0V, V_{DS}=15V$	--	2586	--	pF
Output Capacitance	C_{oss}		--	1478	--	
Reverse Transfer Capacitance	C_{rss}		--	86	--	
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=20V, V_{GS}=10V, R_G=4.7\Omega,$ $I_D=22.5A$ (Notes 4, 5)	--	11	--	ns
Turn-on Rise Time	t_r		--	59	--	
Turn-off Delay Time	$t_{d(off)}$		--	49	--	
Turn-off Fall Time	t_f		--	19	--	
Total Gate Charge	Q_g	$V_{DD}=15V, V_{GS}=10V, I_D=45A$ (Notes 4, 5)	--	40	--	nC
Gate-source Charge	Q_{gs}		--	13	--	
Gate-drain Charge	Q_{gd}		--	4.1	--	
Gate-plateau Voltage	$V_{plateau}$		--	4.4	--	V

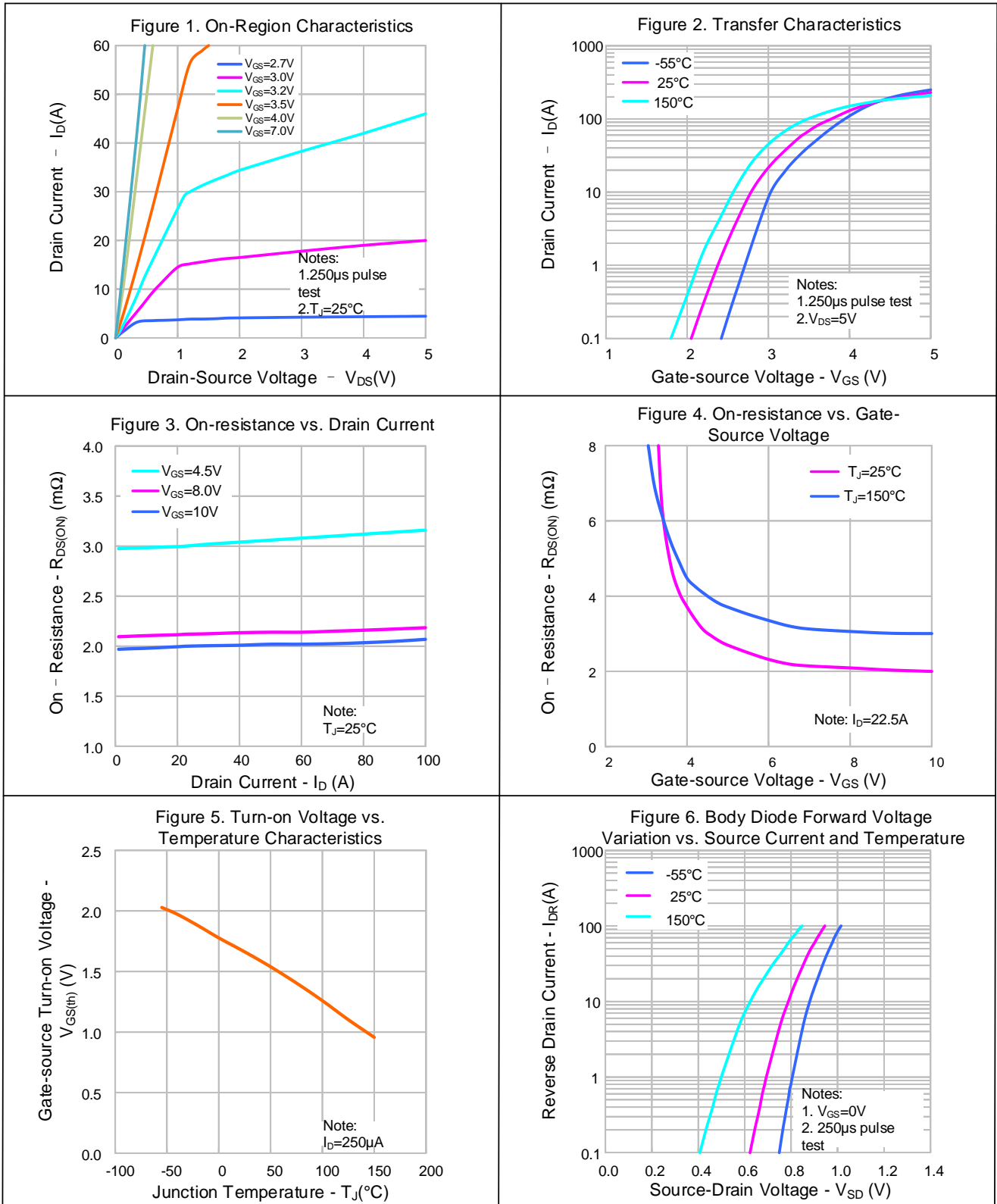
Reverse diode characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Continuous Diode Forward Current	I_S	$T_C=25^{\circ}\text{C}$, Integral reverse P-N junction diode in the MOSFET	--	--	100	A
Diode Pulse Current	$I_{S,pulse}$		--	--	200	
Diode Forward Voltage	V_{SD}	$I_S=45A, V_{GS}=0V$	--	--	1.4	V
Reverse Recovery Time	T_{rr}	$I_S=45A, V_{GS}=0V, V_R=30V,$	--	43	--	ns
Reverse Recovery Charge	Q_{rr}	$dI_F/dt=100A/\mu s$ (Note 4)	--	34	--	nC

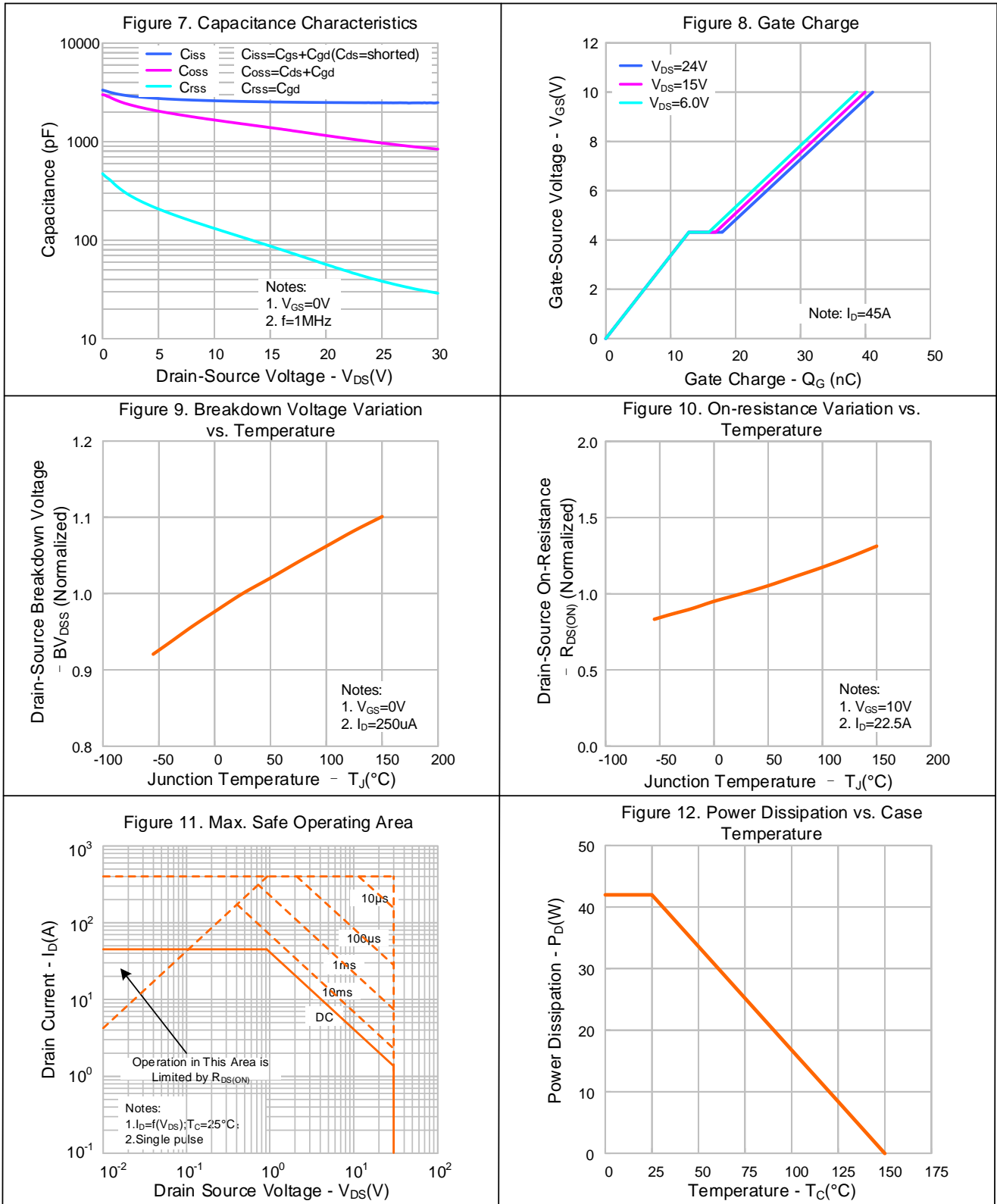
Notes:

- The rated value only refers to the maximum absolute value at the case temperature of 25°C in the specification. If the case temperature is higher than 25°C , it should be derated according to the actual environmental conditions;
- Pulse time $5\mu s$, pulse width is limited by the maximum junction temperature;
- The dissipation power will change with temperature, derating above 25°C : $0.34W/^{\circ}\text{C}$;
- Pulse Test: Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$;
- Essentially independent of operating temperature.

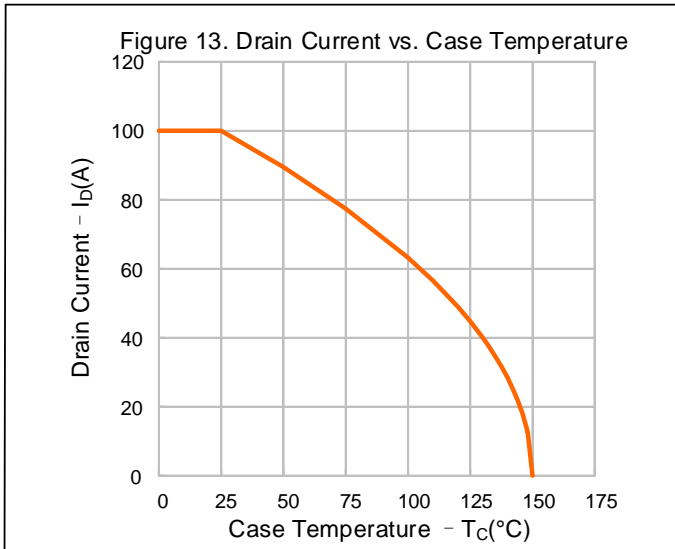
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (CONTINUED)

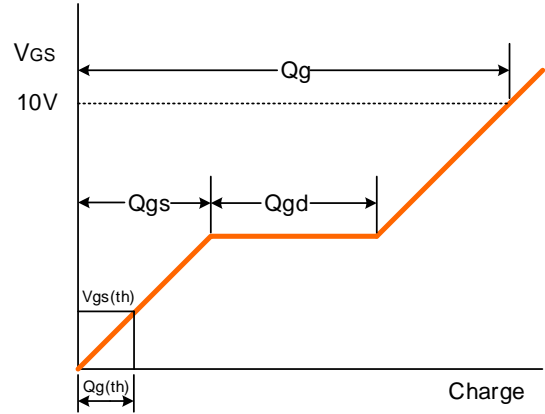
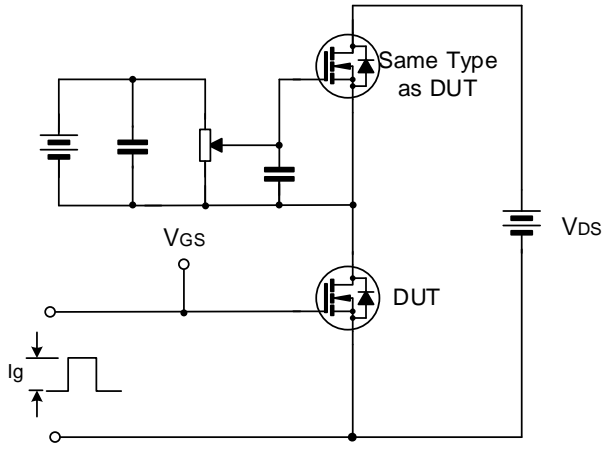


TYPICAL CHARACTERISTICS (CONTINUED)

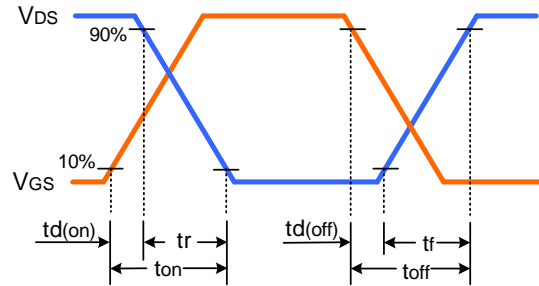
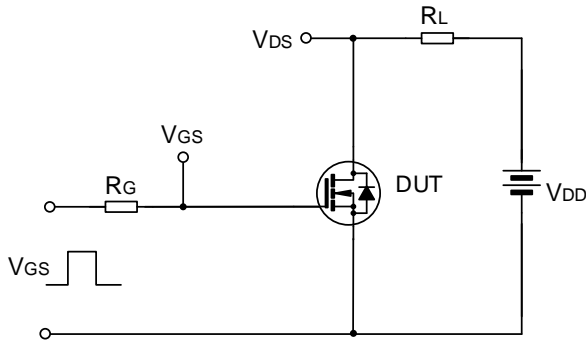


TYPICAL TEST CIRCUIT

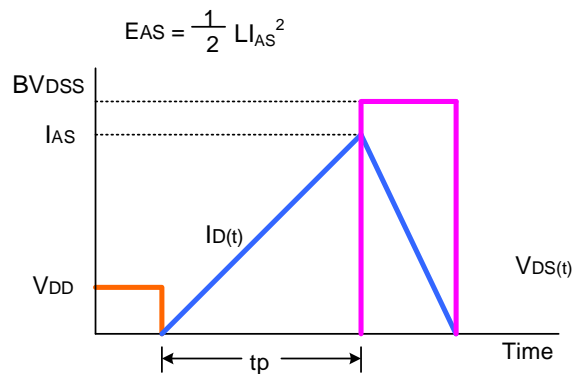
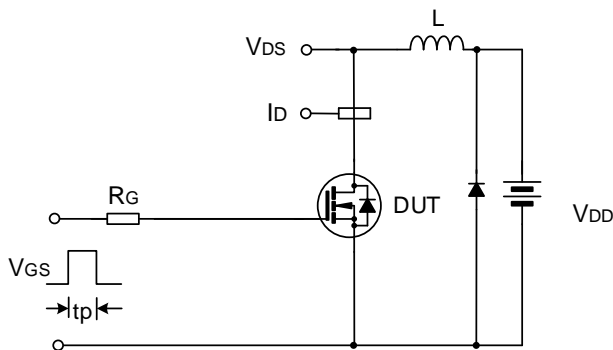
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform



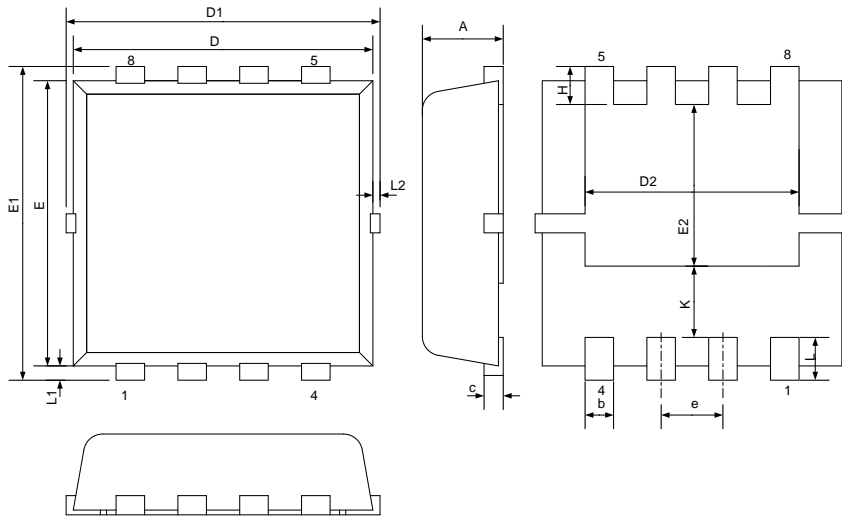
Unclamped Inductive Switching Test Circuit & Waveform



PACKAGE OUTLINE

PDFN-8-3.3x3.3x0.75-0.65

UNIT: mm



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	0.70	0.80	0.90
c	0.14	0.15	0.20
b	0.25	0.30	0.35
D	3.05	3.15	3.25
D1	3.30 BSC		
D2	2.15	2.25	2.35
E	2.90	3.00	3.10
E1	3.30 BSC		
E2	1.60	1.70	1.80
e	0.60	0.65	0.70
H	0.25	0.40	0.55
K	0.65	0.75	0.85
L	0.30	0.45	0.60
L1	0.10	0.15	0.20
L2	—	—	0.15



MOS DEVICES OPERATE NOTES:

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the MOS electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- MOS devices should be packed in antistatic/conductive containers for transportation.

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Rev.: **1.2**

Revision History:

1. Delete the wave soldering condition
 2. Update the typical test circuit
 3. Update the important notice
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Rev.: **1.1**

Revision History:

1. Update package outline
-

Rev.: **1.0**

Revision History:

1. First release
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